

MOSFET - N-Channel, POWERTRENCH®

80 V, 50 A, 13.4 m Ω

FDMS86380-F085

Features

- Typ $R_{DS(on)} = 11.3 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$; $I_D = 50 \text{ A}$
- Typ $Q_{g(tot)} = 20 \text{ nC}$ at $V_{GS} = 10 \text{ V}$; $I_D = 50 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12 V Systems

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

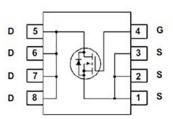
Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V_{DSS}	80	V
Gate-to-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (V _{GS} = 10 V) (Note 1)	T _C = 25°C	I _D	50	Α
Pulsed Drain Current	T _C = 25°C		See Figure 4	
Single Pulse Avalanche Energy (Note 2)		E _{AS}	16	mJ
Power Dissipation		P_{D}	75	W
Derate above 25°C		0.5	W/°C	
Operating and Storage Temperature		T _J , T _{STG}	-55 to +175	°C
Thermal Resistance (Junction-to-Case)		$R_{\theta JC}$	2	°C/W
Maximum Thermal Resistance (Junction-to-Ambient) (Note 3)		$R_{ heta JA}$	50	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

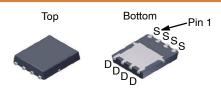
- 1. Current is limited by bondwire configuration.
- 2. Starting Tj = 25°C, \dot{L} = 20 μ H, I_{AS} = $\dot{40}$ A, V_{DD} = 80 V during inductor charging and V_{DD} = 0 V during time in avalanche.
- 3. R_{θ,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θ,JC} is guaranteed by design while R_{θ,JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
80 V	13.4 mΩ @ 10 V	50 A	

ELECTRICAL CONNECTION



N-Channel MOSFET



PQFN8 CASE 483BJ

MARKING DIAGRAM



A = Assembly Location

WL = Wafer Lot
 Y = Year
 WW = Work Week

FDMS86380 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDMS86380-F085	PQFN8 (Power 56) (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					-	
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		80	-	-	V
I _{DSS} Drain-to-Source	Drain-to-Source Leakage Current	V _{DS} = 80 V, V _{GS} = 0 V	T _J = 25°C	-	-	1	μΑ
			T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20 V	V _{GS} = ±20 V		-	±100	nA
ON CHARA	CTERISTICS					-	
V _{GS(th)}	Gate-to-Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250$	μΑ	2.0	3.0	4.0	V
R _{DS(on)}	Drain-to-Source On-Resistance	I _D = 50 A	T _J = 25°C	-	11.3	13.4	mΩ
		V _{GS} = 10 V	T _J = 175°C (Note 4)	-	25.3	30.0	
DYNAMIC C	CHARACTERISTICS		-			-	
C _{iss}	Input Capacitance	V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz		-	1440	-	pF
C _{oss}	Output Capacitance			-	300	-	
C _{rss}	Reverse Transfer Capacitance			-	14	-	
R _g	Gate Resistance	f = 1 MHz		-	2.0	-	Ω
Q _{g(tot)}	Total Gate Charge	V _{GS} = 0 to 10 V V _{DD} = 64 V,	-	20	30	nC	
Q _{g(th)}	Threshold Gate Charge	V _{GS} = 0 to 2 V		-	2.7	-	
Q _{gs}	Gate-to-Source Gate Charge			-	8.8	-	
Q _{gd}	Gate-to-Drain "Miller" Charge			-	4.4	-	
SWITCHING	CHARACTERISTICS					-	
t _{on}	Turn-On Time	V _{DD} = 40 V, I _D = 50 A,		-	-	31	ns
t _{d(on)}	Turn-On Delay	V _{GS} = 10 V, R _{GEN} =	6 Ω	-	13	-	
t _r	Rise Time	7			8	-	
t _{d(off)}	Turn-Off Delay	7			15	-	
t _f	Fall Time			-	5	-	
t _{off}	Turn-Off Time			-	-	30	
DRAIN-SO	URCE DIODE CHARACTERISTICS						
V _{SD}	Source-to-Drain Diode Voltage	I _{SD} = 50 A, V _{GS} = 0 V		_	_	1.25	V
		I _{SD} = 25 A, V _{GS} = 0	V	-	-	1.2	
t _{rr}	Reverse Recovery Time	$I_F = 50 \text{ A}, \text{ d}I_{SD}/\text{d}t = 100 \text{ A}/\mu\text{s}, \text{ V}_{DD} = 64 \text{ V}$		-	37	55	ns
Q _{rr}	Reverse Recovery Charge			_	23	35	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production

TYPICAL CHARACTERISTICS

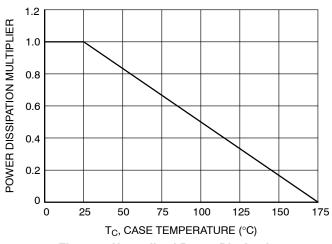


Figure 1. Normalized Power Dissipation vs.

Case Temperature

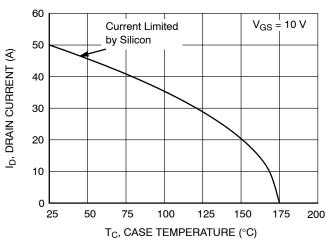


Figure 2. Maximum Continuous Drain Current vs.

Case Temperature

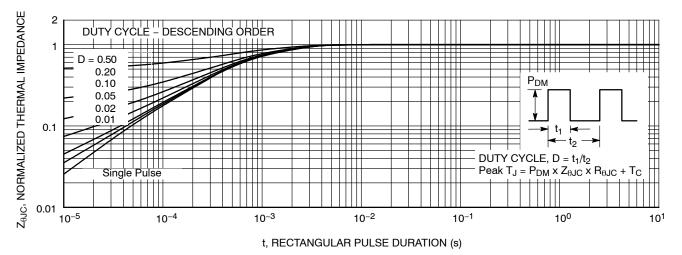


Figure 3. Normalized Maximum Transient Thermal Impedance

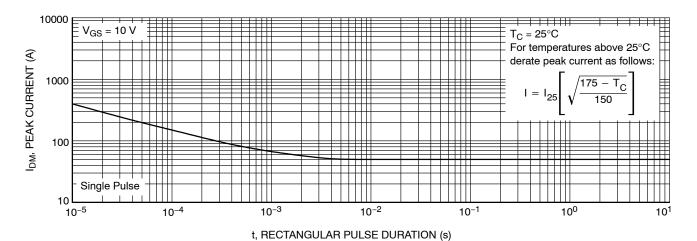
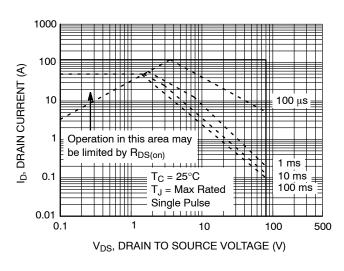


Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)



(Note: Refer to **onsemi** Applications Notes <u>AN7514</u> and <u>AN7515</u>)

Figure 5. Forward Bias Safe Operating Area

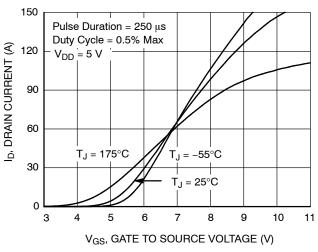


Figure 6. Unclamped Inductive Switching Capability

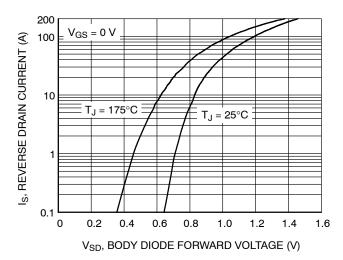


Figure 7. Transfer Characteristics

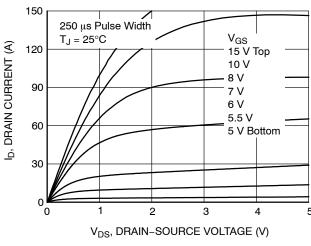


Figure 8. Forward Diode Characteristics

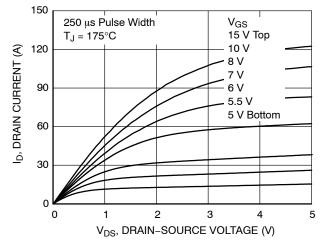


Figure 9. Saturation Characteristics

Figure 10. Saturation Characteristics

TYPICAL CHARACTERISTICS (continued)

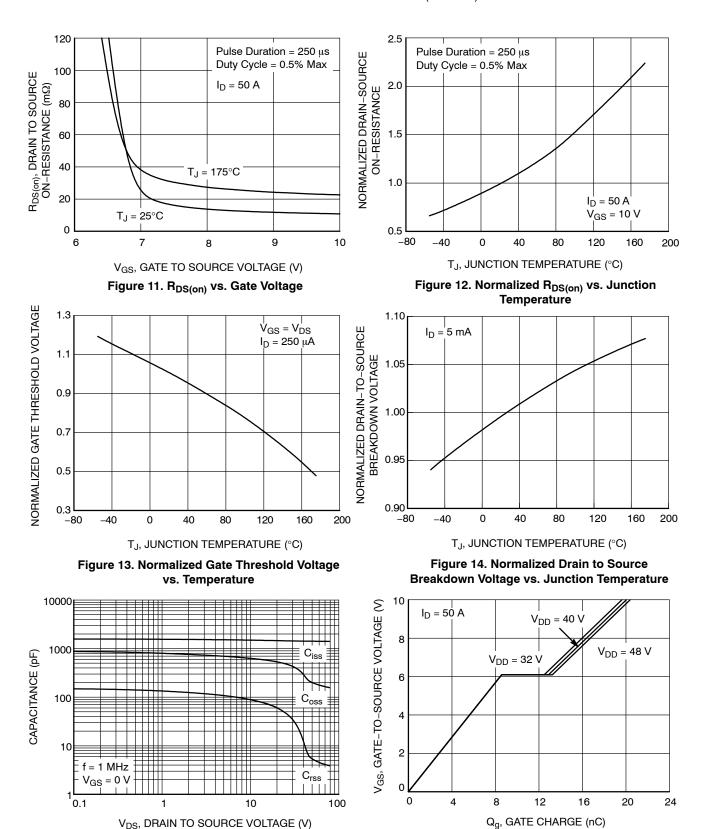


Figure 16. Gate Charge vs. Gate to Source Voltage

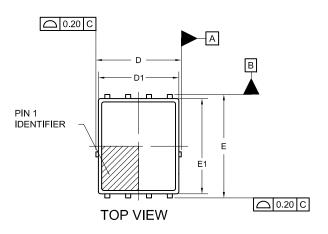
Figure 15. Capacitance vs. Drain to Source

Voltage



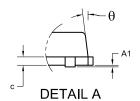
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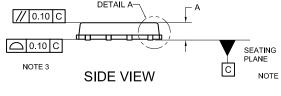


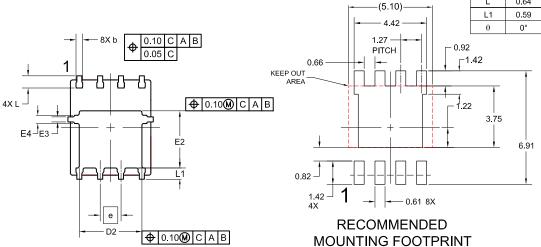
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.
- 4. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.
- SEATING PLANE IS DEFINED BY THE TERMINALS. A1
 IS DEFINED AS THE DISTANCE FROM THE SEATING
 PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.



	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0.00	0.025	0.05	
b	0.31	0.41	0.51	
С	0.23	0.28	0.33	
D	4.90	5.00	5.10	
D1	4.80	4.90	5.00	
D2	3.72	3.82	3.92	
E	6.20	6.30	6.40	
E1	5.70	5.80	5.90	
E2	3.38	3.48	3.58	
E3	0.30			
E4	0.50			
е	1.27 BSC			
L	0.64	0.74	0.84	
L1	0.59	0.69	0.79	
θ	0°	_	12°	





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